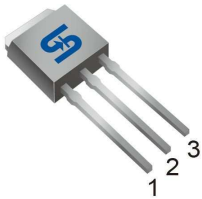
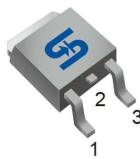




TO-251
(IPAK)



TO-252
(DPAK)



Pin Definition:

1. Gate
2. Drain
3. Source

PRODUCT SUMMARY

V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A)
500	0.85 @ $V_{GS}=10V$	7.2

Features

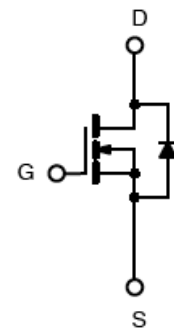
- Low On-Resistance.
- High power and current handling capability.

Ordering Information

Part No.	Package	Packing
TSM8N50CH C5G	TO-251	75pcs / Tube
TSM8N50CP ROG	TO-252	2.5Kpcs / 13" Reel

Note: "G" denotes for Halogen Free

Block Diagram



N-Channel MOSFET

Absolute Maximum Rating ($T_C = 25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current	I_D	$T_C = 25^\circ C$	7.2
		$T_C = 100^\circ C$	4.3
Pulsed Drain Current ^(Note 1)	I_{DM}	28.8	A
Single Pulse Avalanche Energy ^(Note 2)	E_{AS}	181	mJ
Total Power Dissipation @ $T_C = 25^\circ C$	P_{TOT}	89	W
Operating Junction Temperature	T_J	150	$^\circ C$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ C$

Note1: Repetitive Rating : Pulse width limited by maximum junction temperature.

Note2: $L=7mH$, $I_{AS} = 8A$, $V_{DD} = 50V$, $V_{DS} = 200V$, Starting $T_J = 25^\circ C$

Thermal Performance

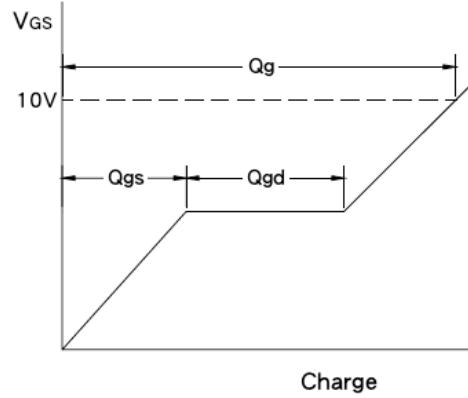
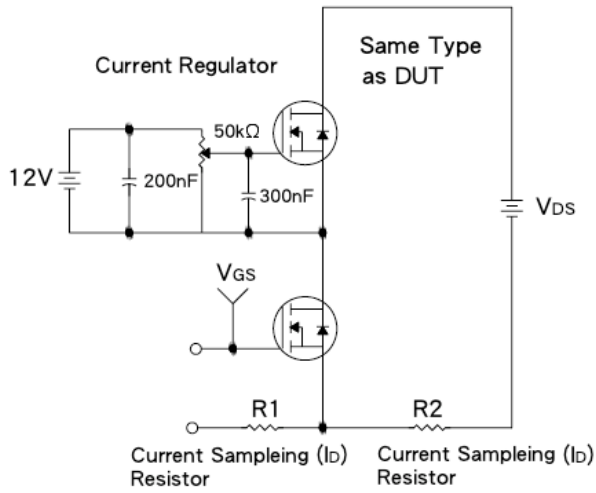
Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Case	$R_{\theta_{JC}}$	1.4	$^\circ C/W$
Thermal Resistance - Junction to Ambient	$R_{\theta_{JA}}$	50	

Electrical Specifications ($T_c = 25^\circ\text{C}$ unless otherwise noted)

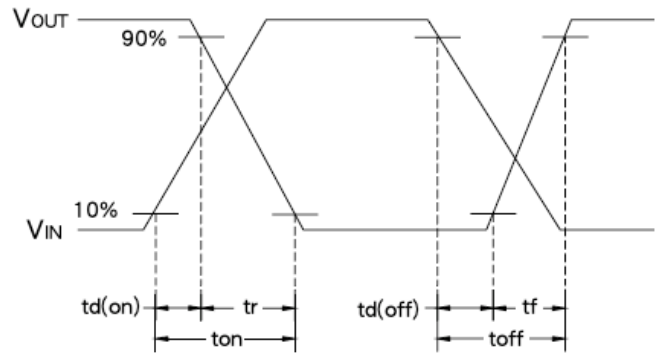
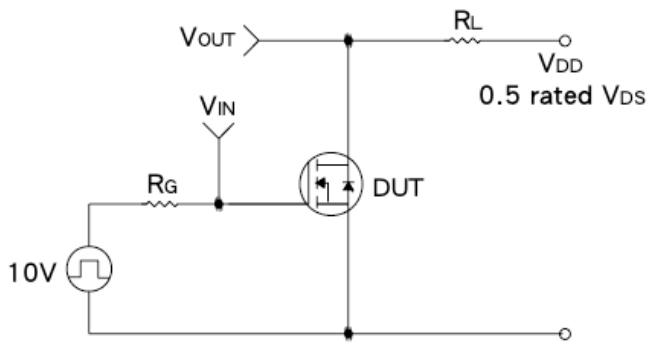
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	500	--	--	V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 3.6A$	$R_{DS(ON)}$	--	0.7	0.85	Ω
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	2.0	3.0	4.0	V
Zero Gate Voltage Drain Current	$V_{DS} = 500V, V_{GS} = 0V$	I_{DSS}	--	--	1	μA
Gate Body Leakage	$V_{GS} = \pm 30V, V_{DS} = 0V$	I_{GSS}	--	--	± 100	nA
Dynamic (Note a)						
Total Gate Charge	$V_{DD} = 400V, I_D = 7A,$ $V_{GS} = 10V$	Q_g	--	26.6	--	nC
Gate-Source Charge		Q_{gs}	--	5.4	--	
Gate-Drain Charge		Q_{gd}	--	6.82	--	
Input Capacitance	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1.0\text{MHz}$	C_{iss}	--	1595	--	pF
Output Capacitance		C_{oss}	--	127.4	--	
Reverse Transfer Capacitance		C_{rss}	--	14.5	--	
Switching (Note a)						
Turn-On Delay Time	$V_{GS} = 10V, I_D = 7A,$ $V_{DD} = 250V, R_{GEN} = 9.1\Omega$	$t_{d(on)}$	--	22	--	nS
Turn-On Rise Time		t_r	--	6.8	--	
Turn-Off Delay Time		$t_{d(off)}$	--	42	--	
Turn-Off Fall Time		t_f	--	4.8	--	
Source-Drain Diode Ratings and Characteristic						
Source Current		I_S	--	--	7	A
Diode Forward Voltage	$I_S = 7A, V_{GS} = 0V$	V_{SD}	--	--	1.5	V

Note a: Pulse Test : Pulse Width < 300 μ s, Duty Cycle < 2%.

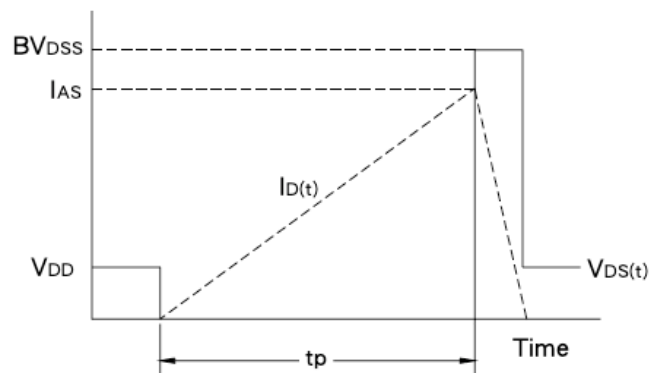
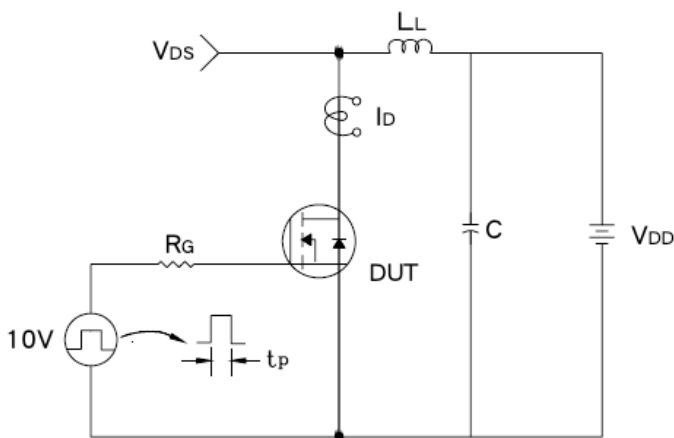
Gate Charge Test Circuit & Waveform



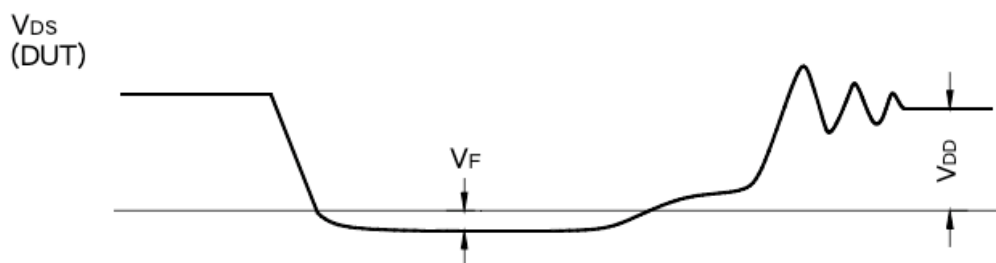
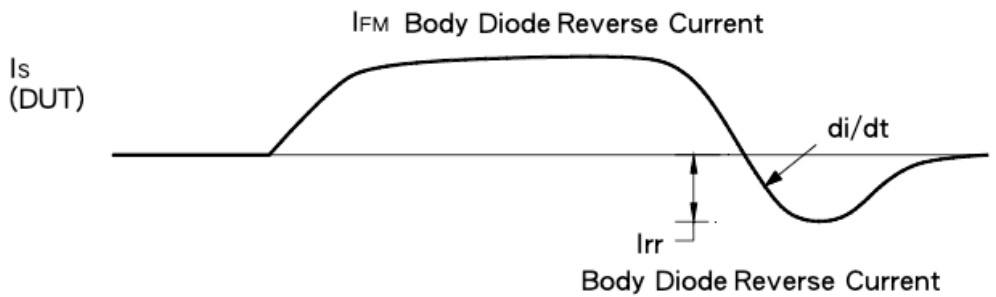
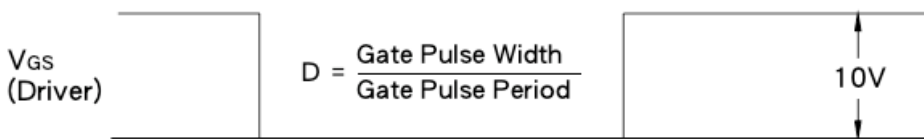
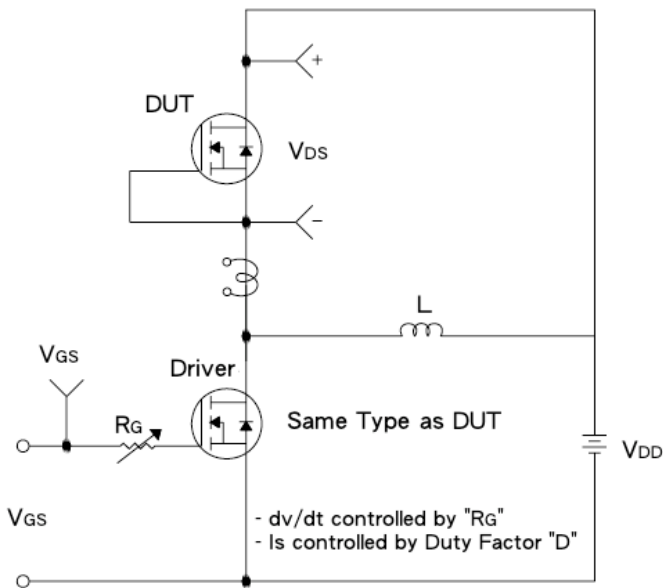
Resistive Switching Test Circuit & Waveform



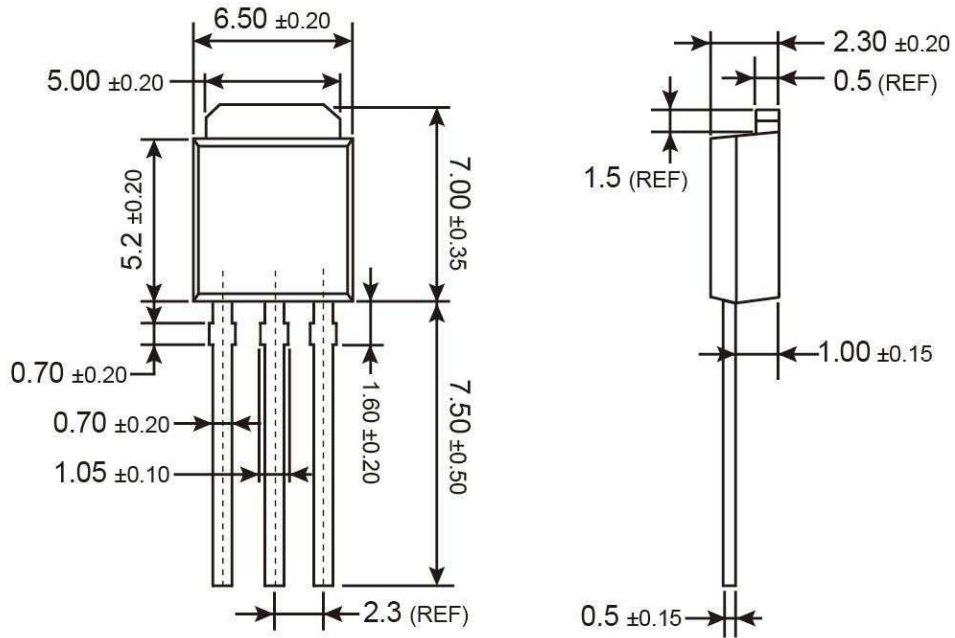
EAS Test Circuit & Waveform



Diode Reverse Recovery Time Test Circuit & Waveform

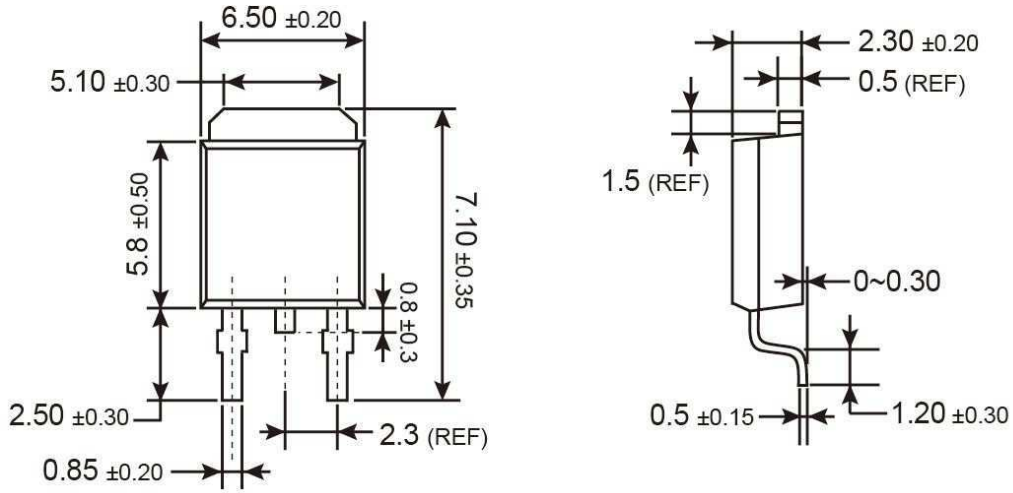


TO-251 Mechanical Drawing



Unit: Millimeters

TO-252 Mechanical Drawing



Unit: Millimeters

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